# **Technical Datasheet** Structalit® 3060



## **Product Description**

## Modified epoxy | 1 part | solvent-free | heat-curing

- Die attach
- Encapsulation

- Very flexible
- Fast curing
- Low ion content <10ppm</p>

## **Curing Properties**

This adhesive must be cured with heat. Typical curing temperatures are listed in the table below.

Temperatures	Time
120°C	90 sec
150°C	45 sec
180°C	20 sec

No more than 0.4 g of adhesive may be cured at one time.

The heat cure times are only provided as a guideline. Actual cure times can vary based on part size, configuration, adhesive volume and temperature control required for the component substrates to attain oven temperature.

The final bond strength of the adhesive is achieved no sooner than 24 h after the bonded components are removed from the oven.

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Technical Data		
Resin	Ероху	
Appearance (100μm)	Transparent	
Appearance (1mm)	Translucent	
Uncured Material		
Viscosity [mPas] (Brookfield LVT, 25 °C, Sp.4/6 rpm)	20,000, 40,000	
PE-Standard 001	30,000 – 40,000	
Viscosity [mPas] (Kinexus Rheometer, 25 °C, 10s <sup>-1</sup> )	4,000 – 7,000	
PE-Standard 064	4,000 – 7,000	
Thixotropic index [1/10]	3.5 – 4.5	
PE-Standard 064	5.5 – 4.5	
Density [g/cm³]	1.1 – 1.2	
PE-Standard 004	1.1 1.2	
Refractive index [nD20]	1.48 – 1.49	
PE-Standard 023		
Cured Material		
Hardness shore D	35 – 45	
PE-Standard 006	33-43	
Temperature resistance [°C]	-40 – 180	
Volume shrinkage [%]		
PE-Standard 032	<6	
Water absorption [wt%]	<4	
PE-Standard 016	\4	
Glass transition temperature - DSC [°C]	40. 50	
PE-Standard 009	40 – 50	
Coefficient of thermal expansion [ppm/K] below Tg	20 – 70	
PE-Standard 017	20 – 70	
Coefficient of thermal expansion [ppm/K] above Tg	200 – 400	
PE-Standard 017	200 – 400	
Lap shear strength (steel/steel) [MPa]		
120°C, 15min	8	
PE-Standard 013		
Lap shear strength (AI/AI) [MPa]		
120°C, 15min	5	
PE-Standard 013		

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# **Transport/Storage/Shelf Life**

Package type	Transport	Storage	Shelf life*
Syringe/Cartridge	0°C – 10°C	0°C – 10°C	At delivery min. 4.5 months max. 9 months
Other packages			

<sup>\*</sup>Store in original, unopened containers!

### **Instructions for use**

#### **Surface preparation**

The surfaces to be bonded should be free of dust, oil, grease, mold release, or other contaminants in order to obtain an optimal and reproducible bond. For cleaning we recommend the cleaner IP® from Panacol, or a solution of Isopropyl Alcohol at 90% or higher concentration. Substrates with low surface energy (e.g. polyethylene, polypropylene) must be pretreated in order to achieve sufficient adhesion.

### **Application**

Our products are supplied ready to use. Depending on packaging they can be applied by hand directly from the container or by using compatible dispensing systems and automation. Many commercially available valve and controller options are available to ensure accurate and consistent adhesive dispensing. For assistance with dispensing and curing questions, please contact our Applications Engineering department. To obtain best results, the adhesive and substrates to be bonded may not be cold and should be allowed to warm to room temperature prior to processing. For safety information refer to our Material Safety Data Sheet (MSDS).

### **Storage**

Store uncured product in its original, closed container in a dry location. Any material removed from the original container must not be returned to the container as it could be contaminated. Panacol cannot assume responsibility for products that were improperly stored, contaminated, or repackaged into other containers.

## **Handling and Clean-up**

For safe handling information, consult this product's Material Safety Data Sheet (MSDS) prior to use. Uncured material may be wiped away from surfaces with organic solvents. Do not use solvents to remove material from eyes or skin!

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#### **Disclaimer**

The product is free of heavy metals, PFOS and Phthalates and is conform to the current EU-Directive RoHS.

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